EXL1V0705 High current molded inductor



Product features

- High current carrying capacity
- Low DCR, high efficiency
- · Magnetically shielded, low EMI
- · Soft saturation
- Inductance range from 2.2 μH to 5.6 μH
- Current range from 10 A to 17 A
- 8.7 mm x 8.3 mm footprint surface mount package in a 5.0 mm height
- Alloy powder core material
- Moisture Sensitivity Level (MSL) 1

Applications

- Voltage Regulator Module (VRM)
- Multi-phase regulators
- Point-of-load (POL) converters
- Desktop and server VRMs and EVRDs
- Base station equipment
- Battery power systems
- · Graphics cards
- Data networking and storage system

Environmental compliance and general specifications

- Storage temperature range (Component): -40 °C to +125 °C
- Operating temperature range: -40 °C to +125 °C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020 (latest revision) compliant





Product specifications

Part number⁵	OCL ¹ (μH) ± 20%	FLL² (µH) minimum	I _{rms} ³ (A) typic +20 °C rise	al +40 °C rise	I _{sat} ⁴ (A)	DCR (mΩ) typical @ +25 °C	DCR (mΩ) maximum @ +25 °C	SRF (MHz) typical
EXL1V0705-2R2-R	2.2	1.23	11	14	17	5.8	6.4	27
EXL1V0705-3R3-R	3.3	1.84	10	13	14	10.4	11.44	20
EXL1V0705-4R7-R	4.7	2.63	8.5	11	13	14	15.4	17
EXL1V0705-5R6-R	5.6	3.13	7	10	11	15.6	17.2	15

1. Open circuit inductance (OCL) Test parameters: 100 kHz, 0.1 V $_{\rm rms'}$ 0.0 Adc, +25 °C

2. Full load inductance (FLL) Test parameters: 100 kHz, 0.1 V_{rms}, I_{sat}, , +25 °C

3. I_{ms} : Heat rated current (I_{ms}) will cause the part temperature rise approximately ΔT of 40 °C. Circuit design,

component, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application. The part temperature (ambient + temp rise) should not exceed +125 °C under worst case operating conditions.

4. I_{sat}: Peak current for approximately 30% rolloff @ +25 °C 5. Part number definition: EXL1V0705-xxx-R

EXL1V0705 = Product code and size

xxx= inductance value in µH, R= decimal point,

If no R is present then third digit equals the number of zeros

-R suffix = RoHS compliant

6. Rated operating voltage: 40 V typical

Mechanical parameters, schematic, pad layout (mm)



Part marking: 0705, xxx= Inductance value in µH (R= Decimal point, if no R is present then last digit equals number of zeros), yyyy= Lot code All soldering surfaces to be coplanar within 0.1 millimeters

Tolerances are ± 0.3 millimeters unless stated otherwise

Dimensions of recommended PCB layout are reference only.

Pad layout tolerances are \pm 0.1 millimeters unless stated otherwise

Four terminal kelvin-clip recommended for DCR testing as shown in Figure 1.

Traces or vias underneath the inductor is not recommended.

Packaging information (mm)

Drawing not to scale

Supplied in tape and reel packaging, 800 parts per 13" diameter reel (EIA-481 compliant)



W ± 0.30	16
F ± 0.1	7.5
E1 ± 0.1	1.75
P0 ± 0.1	4.0
P1 ± 0.1	12
P2 ± 0.1	2.0
D0 + 0.1/-0	1.5
D1 + 0.1/-0	1.5
A0 ± 0.1	8.8
B0 ± 0.1	8.4
K0 ± 0.1	5.3
T ± 0.05	0.4
P0 X 10 ± 0.2	40

Qualification testing

No.	Test item	Reference standards	Test condition	Acceptable value/range
1	Life	MIL-STD-202 Method 108	+125 °C + I_{rms} for 1000 hours	a. Appearance b. ΔL/L<±10% d. ΔR/R<±15%
2	Load humidity	MIL-STD-202 Method 103	+85 °C/85% RH +I _{rms} for 1000 hours	a. Appearance b. ΔL/L<±10% d. ΔR/R<±15%
3	Moisture resistance	MIL-STD-202 Method 106	7a & 7b included	a. Appearance b. ΔL/L<±10% d. ΔR/R<±15%
4	Thermal shock	MIL-STD-202 Method 107	Step 1: -40 \pm 2 °C 30 \pm 5 minutes Step 2: 25 \pm 2 °C \leq 0.5 minutes Step 3: 125 \pm 2 °C 30 \pm 5 minutes Number of cycles: 500	a. Appearance b. $\Delta L/L < \pm 10\%$ d. $\Delta R/R < \pm 15\%$
5	Vibration	MIL-STD-202 Method 204	10 g, 12 hours (10 Hz ~ 2 kHz ~ 10 Hz for 20 minutes, 12 cycles each of 3 orientations)	a. Appearance b. ΔL/L<±10% d. ΔR/R<±15%
6	Shock	MIL-STD-202 Method 213	Half-sine 50 g's, 11 ms	a. Appearance b. ΔL/L<±10% d. ΔR/R<±15%
7	Bending	IEC 68-2-21	1.2 mm for 10 s	a. Appearance b. ΔL/L<±10% d. ΔR/R<±15%
8	Solderability	J-STD-002D Method B	$\begin{array}{llllllllllllllllllllllllllllllllllll$	
9	Resistance to soldering heat	MIL-STD-202 Method 210	+260 ± 5 °C; 10 ± 1 s	a. Appearance b. ΔL/L<±10% d. ΔR/R<±15%
10	Terminal strength	AEC-0200-006	1 kg for 60 + 1 s	a. Appearance b. ΔL/L<±10% d. ΔR/R<±15%

Inductance and temperature rise vs. current



EXL1V0705 High current molded inductor

Inductance and impedance vs. frequency curve



Solder reflow profile



Table 1 - Standard SnPb solder (T_c)

Package thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2 - Lead (Pb) free solder (T_c)

Package thickness	Volume mm³ <350	Volume mm ³ 350 - 2000	Volume mm ³ >2000	
<1.6 mm	260 °C	260 °C	260 °C	
1.6 – 2.5 mm	260 °C	250 °C	245 °C	
>2.5 mm	250 °C	245 °C	245 °C	

Reference J-STD-020

Powerina Business Worldwide

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat and soak • Temperature min. (T _{smin})	100 °C	150 °C
• Temperature max. (T _{smax})	150 °C	200 °C
• Time (T _{smin} to T _{smax}) (t _s)	60-120 seconds	60-120 seconds
Ramp up rate T _L to T _p	3 °C/ second max.	3 °C/ second max.
Liquidous temperature (TL) Time (tL) maintained above ${\rm T_L}$	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak package body temperature (Tp)*	Table 1	Table 2
Time $(t_p)^*$ within 5 °C of the specified classification temperature (T_c)	20 seconds*	30 seconds*
Ramp-down rate (T _p to T _L)	6 °C/ second max.	6 °C/ second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

 * Tolerance for peak profile temperature (T_D) is defined as a supplier minimum and a user maximum.

Life Support Policy: Eaton does not authorize the use of any of its products for use in life support devices or systems without the express written approval of an officer of the Company. Life support systems are devices which support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

Eaton reserves the right, without notice, to change design or construction of any products and to discontinue or limit distribution of any products. Eaton also reserves the right to change or update, without notice, any technical information contained in this bulletin.

Eaton Electronics Division 1000 Eaton Boulevard Cleveland, OH 44122 United States Eaton.com/electronics

© 2020 Eaton All Rights Reserved Printed in USA Publication No. 11194 BU-MC20171 November 2020

Eaton is a registered trademark.

All other trademarks are property of their respective owners.

Follow us on social media to get the latest product and support information.



X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Fixed Inductors category:

Click to view products by Eaton manufacturer:

Other Similar products are found below :

CR43NP-680KC CR54NP-820KC CR54NP-8R5MC CTX32CT-100 70F224AI MGDQ4-00004-P MHL1ECTTP18NJ MHL1JCTTD12NJ PE-51506NL PE-53601NL PE-53602NL PE-53630NL PE-53824SNLT PE-62892NL PE-92100NL PG0434.801NLT PG0936.113NLT 9310-16 PM06-2N7 PM06-39NJ A01TK 1206CS-471XJ HC2-2R2TR HC2LP-R47-R HC3-2R2-R 1206CS-151XG RCH664NP-140L RCH664NP-4R7M RCH8011NP-221L RCP1317NP-332L RCP1317NP-391L RCR1010NP-470M RCR110DNP-331L DH2280-4R7M DS1608C-106 ASPI-4020HI-R10M-T B10TJ B82477P4333M B82498B3101J000 B82498B3680J000 ELJ-RE27NJF2 1812CS-153XJ 1812CS-183XJ 1812CS-223XJ 1812LS-104XJ 1812LS-105XJ 1812LS-124XJ 1812LS-154XJ 1812LS-223XJ 1812LS-224XJ